Free Height

TE Internal #: 120521-1

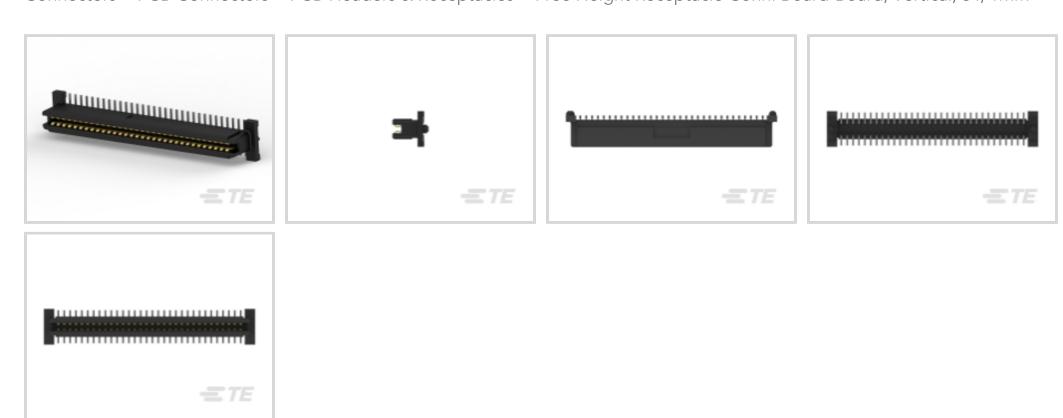
PCB Mount Receptacle, Vertical, Board-to-Board, 64 Position, .039 in [1 mm] Centerline, Gold, Surface Mount, Signal, Black, Free

Height

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Free Height Receptacle Conn: Board-Board, Vertical, 64, 1mm



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 64

Centerline (Pitch): 1 mm [.039 in]

All Free Height Receptacle Conn: Board-Board, Vertical, 64, 1mm (57)

Features

Product Type Features

| PCB Connector Assembly Type | PCB Mount Receptacle |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Number of Columns | 32 |
| Stackable | Yes |
| PCB Mount Orientation | Vertical |
| Number of Positions | 64 |
| Board-to-Board Configuration | Parallel |
| Electrical Characteristics | |
| Insulation Resistance | 2 ΜΩ |



| Signal Characteristics Differential Signaling Yes Body Features | |
|---|--------|
| | |
| Body Features | |
| | |
| Primary Product Color Black | |
| Contact Features | |
| Contact Layout Inline | |
| Contact Mating Area Length 2 mm | |
| PCB Contact Termination Area Plating Material Thickness 3.81 µm[150 µ | ıin] |
| Mating Tab Width .63 mm[.024 in | n] |
| Mating Tab Thickness .2 mm[.008 in] |] |
| Contact Underplating Material Thickness 1.27 µm[50 µir | n] |
| PCB Contact Termination Area Plating Material Finish Matte | |
| Contact Shape & Form Single Beam | |
| PCB Contact Termination Area Plating Material Tin-Lead | |
| Contact Base Material Phosphor Bro | onze |
| Contact Mating Area Plating Material Gold | |
| Contact Mating Area Plating Material Thickness .76 µm[29.921 | 2 μin] |
| Contact Type Socket | |
| Contact Current Rating (Max) 1 A | |
| Termination Features | |
| Rectangular Termination Post & Tail Thickness .2 mm[.008 in] |] |
| Rectangular Termination Post & Tail Width .3 mm[.011 in] |] |
| Termination Method to Printed Circuit Board Surface Moun | nt |
| Mechanical Attachment | |
| PCB Mount Alignment Type Locating Post | IS . |
| Mating Retention Without | |
| PCB Mount Retention Type None | |
| Mating Alignment Without | |
| Mating Alignment Type None | |
| PCB Mount Retention Without | |
| PCB Mount Alignment With | |



Housing Features

| riousing reatures | |
|-----------------------------|----------------------------|
| Mating Entry Location | Тор |
| Centerline (Pitch) | 1 mm[.039 in] |
| Housing Material | Matte |
| Dimensions | |
| Connector Width | 3.81 mm[150 in] |
| Stack Height | 8 mm, 9 mm, 10 mm[.394 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 110 °C[-67 – 230 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| Industry Standards | |

| UL Rating | Listed |
|------------------------|-----------------------|
| Agency/Standard | CSA, UL |
| Approved Standards | CSA LR7189, UL E28476 |
| Industry Standard | IEEE 1386 |
| UL Flammability Rating | UL 94V-0 |

Packaging Features

| Packaging Quantity | 650 |
|--------------------|-------------|
| Packaging Type | Tape & Reel |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Not Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Not Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per |



homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

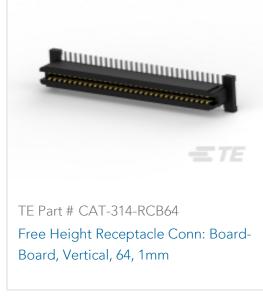
Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

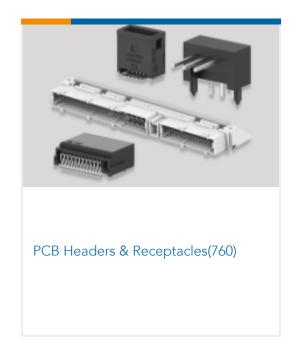








Also in the Series | Free Height



Customers Also Bought



















Documents

Product Drawings

1FHR,64,30A/P,S,N,S08,09,10

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_120521-1_K.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_120521-1_K.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_120521-1_K.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English